- 4.5-V to 5.5-V V<sub>CC</sub> Operation
- Inputs Accept Voltages to 5.5 V
- Max t<sub>pd</sub> of 9.5 ns at 5 V
- Inputs Are TTL-Voltage Compatible

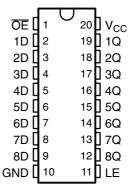
#### description/ordering information

These 8-bit latches feature 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. The devices are particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

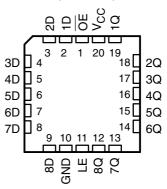
The eight latches are D-type transparent latches. When the latch-enable (LE) input is high, the Q outputs follow the data (D) inputs. When LE is taken low, the Q outputs are latched at the logic levels set up at the D inputs.

A buffered output-enable ( $\overline{OE}$ ) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines in a bus-organized system without need for interface or pullup components.

SN54ACT573 . . . J OR W PACKAGE SN74ACT573 . . . DB, DW, N, NS, OR PW PACKAGE (TOP VIEW)



# SN54ACT573...FK PACKAGE (TOP VIEW)



OE does not affect the internal operations of the latches. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

#### **ORDERING INFORMATION**

| T <sub>A</sub> | PACKAG     | Ε <sup>†</sup> | ORDERABLE<br>PART NUMBER | TOP-SIDE<br>MARKING |
|----------------|------------|----------------|--------------------------|---------------------|
|                | PDIP – N   | Tube           | SN74ACT573N              | SN74ACT573N         |
|                | COIC DW    | Tube           | SN74ACT573DW             | AOT570              |
| 4000 to 0500   | SOIC - DW  | Tape and reel  | SN74ACT573DWR            | ACT573              |
| -40°C to 85°C  | SOP - NS   | Tape and reel  | SN74ACT573NSR            | ACT573              |
|                | SSOP - DB  | Tape and reel  | SN74ACT573DBR            | AD573               |
|                | TSSOP – PW | Tape and reel  | SN74ACT573PWR            | AD573               |
|                | CDIP – J   | Tube           | SNJ54ACT573J             | SNJ54ACT573J        |
| -55°C to 125°C | CFP – W    | Tube           | SNJ54ACT573W             | SNJ54ACT573W        |
|                | LCCC - FK  | Tube           | SNJ54ACT573FK            | SNJ54ACT573FK       |

<sup>&</sup>lt;sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



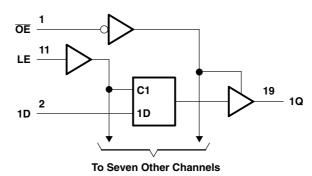
Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



# FUNCTION TABLE (each latch)

|    | INPUTS | OUTPUT |       |
|----|--------|--------|-------|
| ŌĒ | LE     | D      | Q     |
| L  | Н      | Н      | Н     |
| L  | Н      | L      | L     |
| L  | L      | Χ      | $Q_0$ |
| Н  | X      | Χ      | Z     |

#### logic diagram (positive logic)



#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage range, V <sub>CC</sub>   |              | –0.5 V to 7 V                  |
|---|--------------|--------------------------------|
| Input voltage range, V <sub>I</sub> (see Note 1)  |              |                                |
| Output voltage range, V <sub>O</sub> (see Note 1)   |              | . $-0.5$ V to $V_{CC} + 0.5$ V |
| Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ )                                   |              | ±20 mA                         |
| Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0 or V <sub>O</sub> > V <sub>CC</sub> ) | )            | ±20 mA                         |
| Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )                                      |              | ±50 mA                         |
| Continuous current through, V <sub>CC</sub> or GND  |              | ±200 mA                        |
| Package thermal impedance, θ <sub>JA</sub> (see Note 2):  | : DB package | 70°C/W                         |
| -   | DW package   | 58°C/W                         |
|   | N package    | 69°C/W                         |
|   | NS package   | 60°C/W                         |
|   | PW package   | 83°C/W                         |
| Storage temperature range, T <sub>stq</sub>   |              | –65°C to 150°C                 |

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
  - 2. The package thermal impedance is calculated in accordance with JESD 51-7.



#### recommended operating conditions (see Note 3)

|                 |                                    | SN54A | CT573           | SN74A | CT573           |      |
|-----------------|------------------------------------|-------|-----------------|-------|-----------------|------|
|                 |                                    | MIN   | MAX             | MIN   | MAX             | UNIT |
| V <sub>CC</sub> | Supply voltage                     | 4.5   | 5.5             | 4.5   | 5.5             | V    |
| V <sub>IH</sub> | High-level input voltage           | 2     |                 | 2     |                 | V    |
| V <sub>IL</sub> | Low-level input voltage            |       | 0.8             |       | 0.8             | V    |
| VI              | Input voltage                      | 0     | V <sub>CC</sub> | 0     | V <sub>CC</sub> | V    |
| V <sub>O</sub>  | Output voltage                     | 0     | $V_{CC}$        | 0     | $V_{CC}$        | V    |
| I <sub>OH</sub> | High-level output current          |       | -24             |       | -24             | mA   |
| I <sub>OL</sub> | Low-level output current           |       | 24              |       | 24              | mA   |
| Δt/Δν           | Input transition rise or fall rate |       | 8               |       | 8               | ns/V |
| T <sub>A</sub>  | Operating free-air temperature     | -55   | 125             | -40   | 85              | °C   |

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|                    |   |                 | T,   | <sub>A</sub> = 25°C | ;     | SN54A | CT573 | SN74A | CT573 |      |  |  |
|--------------------|---|-----------------|------|---------------------|-------|-------|-------|-------|-------|------|--|--|
| PARAMETER          | TEST CONDITIONS   | V <sub>CC</sub> | MIN  | TYP                 | MAX   | MIN   | MAX   | MIN   | MAX   | UNIT |  |  |
|                    | - FO A  | 4.5 V           | 4.4  | 4.49                |       | 4.4   |       | 4.4   |       |      |  |  |
|                    | $I_{OH} = -50 \mu\text{A}$                                    | 5.5 V           | 5.4  | 5.49                |       | 5.4   |       | 5.4   |       |      |  |  |
| .,                 | 04 704  | 4.5 V           | 3.86 |                     |       | 3.7   |       | 3.76  |       |      |  |  |
| $V_{OH}$           | I <sub>OH</sub> = – 24 mA                                     | 5.5 V           | 4.86 |                     |       | 4.7   |       | 4.76  |       | V    |  |  |
|                    | $I_{OH} = -50 \text{ mA}^{\dagger}$                           | 5.5 V           |      |                     |       | 3.85  |       |       |       |      |  |  |
|                    | $I_{OH} = -75 \text{ mA}^{\dagger}$                           | 5.5 V           |      |                     |       |       |       | 3.85  |       |      |  |  |
|                    | L 50 A  | 4.5 V           |      |                     | 0.1   |       | 0.1   |       | 0.1   |      |  |  |
|                    | $I_{OL} = 50 \mu A$   | 5.5 V           |      |                     | 0.1   |       | 0.1   |       | 0.1   | ٧    |  |  |
| .,                 |   | 4.5 V           |      |                     | 0.36  |       | 0.44  |       | 0.44  |      |  |  |
| $V_{OL}$           | $I_{OL} = 24 \text{ mA}$                                      | 5.5 V           |      |                     | 0.36  |       | 0.44  |       | 0.44  |      |  |  |
|                    | $I_{OL} = 50 \text{ mA}^{\dagger}$                            | 5.5 V           |      |                     |       |       | 1.65  |       |       |      |  |  |
|                    | $I_{OL} = 75 \text{ mA}^{\dagger}$                            | 5.5 V           |      |                     |       |       |       |       | 1.65  |      |  |  |
| I <sub>OZ</sub>    | V <sub>O</sub> = V <sub>CC</sub> or GND                       | 5.5 V           |      |                     | ±0.25 |       | ±5    |       | ±2.5  | μΑ   |  |  |
| I <sub>I</sub>     | V <sub>I</sub> = V <sub>CC</sub> or GND                       | 5.5 V           |      |                     | ±0.1  |       | ±1    |       | ±1    | μА   |  |  |
| Icc                | $V_I = V_{CC}$ or GND, $I_O = 0$                              | 5.5 V           |      |                     | 4     |       | 80    |       | 40    | μΑ   |  |  |
| Δl <sub>CC</sub> ‡ | One input at 3.4 V,<br>Other inputs at GND or V <sub>CC</sub> | 5.5 V           |      | 0.6                 |       |       | 1.5   |       | 1.5   | mA   |  |  |
| C <sub>i</sub>     | V <sub>I</sub> = V <sub>CC</sub> or GND                       | 5 V             |      | 5                   |       |       |       |       |       | pF   |  |  |

<sup>&</sup>lt;sup>†</sup> Not more than one output should be tested at a time, and the duration of the test should not exceed 2 ms.

# timing requirements over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

|                 |                             | T <sub>A</sub> = 25°C |     | SN54ACT573 |     | SN74A | CT573 |      |
|-----------------|-----------------------------|-----------------------|-----|------------|-----|-------|-------|------|
|                 |                             | MIN                   | MAX | MIN        | MAX | MIN   | MAX   | UNIT |
| t <sub>w</sub>  | Pulse duration, LE high     | 3.5                   |     | 5          |     | 4     |       | ns   |
| t <sub>su</sub> | Setup time, data before LE↓ | 3                     |     | 4.5        |     | 3.5   |       | ns   |
| t <sub>h</sub>  | Hold time, data after LE↓   | 0                     |     | 1          |     | 0     |       | ns   |



<sup>&</sup>lt;sup>‡</sup> This is the increase in supply current for each input that is at one of the specified TTL voltage levels, rather than 0 V or V<sub>CC</sub>.

# **SN54ACT573, SN74ACT573 OCTAL D-TYPE TRANSPARENT LATCHES** WITH 3-STATE OUTPUTS SCAS538D - OCTOBER 1995 - REVISED OCTOBER 2002

# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

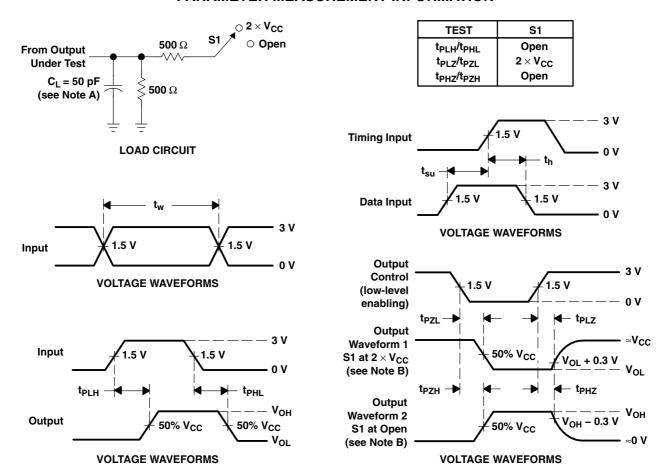
| DADAMETED        | FROM    | то       | T <sub>A</sub> = 25°C |     |      | SN54ACT573 |      | SN74ACT573 |      | LINUT |
|------------------|---------|----------|-----------------------|-----|------|------------|------|------------|------|-------|
| PARAMETER        | (INPUT) | (OUTPUT) | MIN                   | TYP | MAX  | MIN        | MAX  | MIN        | MAX  | UNIT  |
| t <sub>PLH</sub> | D       | 0        | 2.5                   | 6   | 10.5 | 1.5        | 13.5 | 2          | 12   |       |
| t <sub>PHL</sub> | U       | Q        | 2.5                   | 6   | 10.5 | 1.5        | 13.5 | 2          | 12   | ns    |
| t <sub>PLH</sub> | LE      | 0        | 3                     | 6   | 10.5 | 1.5        | 13   | 2.5        | 12   |       |
| t <sub>PHL</sub> | LE      | Q        | 2.5                   | 5.5 | 9.5  | 1.5        | 12   | 2          | 10.5 | ns    |
| t <sub>PZH</sub> | ٥٢      | _        | 2                     | 5.5 | 10   | 1.5        | 11.5 | 1.5        | 11   |       |
| t <sub>PZL</sub> | OE      | Q        | 1.5                   | 5.5 | 9.5  | 1.5        | 11   | 1.5        | 10.5 | ns    |
| t <sub>PHZ</sub> | ŌĒ      | Q        | 2.5                   | 6.5 | 11   | 1.5        | 13.5 | 1.5        | 12.5 | 20    |
| t <sub>PLZ</sub> | OE      | ď        | 1.5                   | 5   | 8.5  | 1.5        | 10.5 | 1          | 9.5  | ns    |

# operating characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C

|          | PARAMETER                     | TEST CO         | NDITIONS  | TYP | UNIT |
|----------|-------------------------------|-----------------|-----------|-----|------|
| $C_{pd}$ | Power dissipation capacitance | $C_L = 50 pF$ , | f = 1 MHz | 25  | pF   |



#### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O = 50 \Omega$ ,  $t_f \leq$  2.5 ns,  $t_f \leq$  2.5 ns.
- D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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#### **PACKAGING INFORMATION**

| Orderable Device | Status | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan            | Lead finish/<br>Ball material | MSL Peak Temp      | Op Temp (°C) | Device Marking (4/5)                    | Samples |
|------------------|--------|--------------|--------------------|------|----------------|---------------------|-------------------------------|--------------------|--------------|---|---------|
| 5962-87664012A   | ACTIVE | LCCC         | FK                 | 20   | 1              | Non-RoHS<br>& Green | SNPB                          | N / A for Pkg Type | -55 to 125   | 5962-<br>87664012A<br>SNJ54ACT<br>573FK | Samples |
| 5962-8766401RA   | ACTIVE | CDIP         | J                  | 20   | 1              | Non-RoHS<br>& Green | SNPB                          | N / A for Pkg Type | -55 to 125   | 5962-8766401RA<br>SNJ54ACT573J          | Samples |
| 5962-8766401SA   | ACTIVE | CFP          | W                  | 20   | 1              | Non-RoHS<br>& Green | SNPB                          | N / A for Pkg Type | -55 to 125   | 5962-8766401SA<br>SNJ54ACT573W          | Samples |
| SN74ACT573DBR    | ACTIVE | SSOP         | DB                 | 20   | 2000           | RoHS & Green        | NIPDAU                        | Level-1-260C-UNLIM | -40 to 85    | AD573                                   | Samples |
| SN74ACT573DW     | ACTIVE | SOIC         | DW                 | 20   | 25             | RoHS & Green        | NIPDAU                        | Level-1-260C-UNLIM | -40 to 85    | ACT573                                  | Samples |
| SN74ACT573DWR    | ACTIVE | SOIC         | DW                 | 20   | 2000           | RoHS & Green        | NIPDAU                        | Level-1-260C-UNLIM | -40 to 85    | ACT573                                  | Samples |
| SN74ACT573N      | ACTIVE | PDIP         | N                  | 20   | 20             | RoHS & Green        | NIPDAU                        | N / A for Pkg Type | -40 to 85    | SN74ACT573N                             | Samples |
| SN74ACT573NSR    | ACTIVE | SO           | NS                 | 20   | 2000           | RoHS & Green        | NIPDAU                        | Level-1-260C-UNLIM | -40 to 85    | ACT573                                  | Samples |
| SN74ACT573PW     | ACTIVE | TSSOP        | PW                 | 20   | 70             | RoHS & Green        | NIPDAU                        | Level-1-260C-UNLIM | -40 to 85    | AD573                                   | Samples |
| SN74ACT573PWR    | ACTIVE | TSSOP        | PW                 | 20   | 2000           | RoHS & Green        | NIPDAU                        | Level-1-260C-UNLIM | -40 to 85    | AD573                                   | Samples |
| SNJ54ACT573FK    | ACTIVE | LCCC         | FK                 | 20   | 1              | Non-RoHS<br>& Green | SNPB                          | N / A for Pkg Type | -55 to 125   | 5962-<br>87664012A<br>SNJ54ACT<br>573FK | Samples |
| SNJ54ACT573J     | ACTIVE | CDIP         | J                  | 20   | 1              | Non-RoHS<br>& Green | SNPB                          | N / A for Pkg Type | -55 to 125   | 5962-8766401RA<br>SNJ54ACT573J          | Samples |
| SNJ54ACT573W     | ACTIVE | CFP          | W                  | 20   | 1              | Non-RoHS<br>& Green | SNPB                          | N / A for Pkg Type | -55 to 125   | 5962-8766401SA<br>SNJ54ACT573W          | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

#### PACKAGE OPTION ADDENDUM

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(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF SN54ACT573, SN74ACT573:

Catalog: SN74ACT573

Military: SN54ACT573

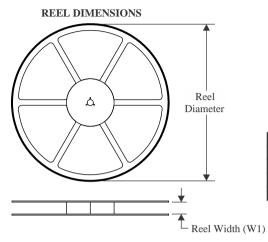
NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

## **PACKAGE MATERIALS INFORMATION**

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#### TAPE AND REEL INFORMATION



# TAPE DIMENSIONS + K0 - P1 - B0 W Cavity - A0 -

| A0 | Dimension designed to accommodate the component width     |
|----|---|
| В0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

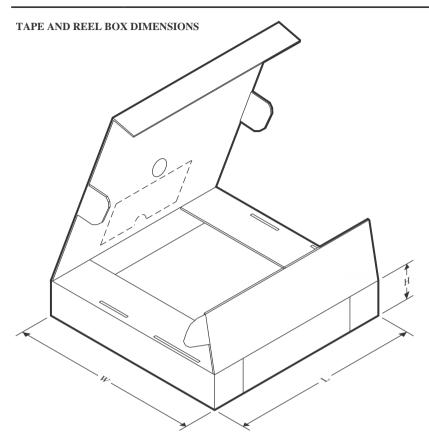


#### \*All dimensions are nominal

| Device        | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|---------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74ACT573DBR | SSOP            | DB                 | 20 | 2000 | 330.0                    | 16.4                     | 8.2        | 7.5        | 2.5        | 12.0       | 16.0      | Q1               |
| SN74ACT573DWR | SOIC            | DW                 | 20 | 2000 | 330.0                    | 24.4                     | 10.8       | 13.3       | 2.7        | 12.0       | 24.0      | Q1               |
| SN74ACT573NSR | so              | NS                 | 20 | 2000 | 330.0                    | 24.4                     | 8.4        | 13.0       | 2.5        | 12.0       | 24.0      | Q1               |
| SN74ACT573PWR | TSSOP           | PW                 | 20 | 2000 | 330.0                    | 16.4                     | 6.95       | 7.1        | 1.6        | 8.0        | 16.0      | Q1               |



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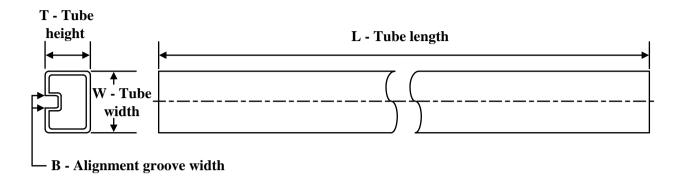
#### \*All dimensions are nominal

|   | 7 till dillitorioriorio di o riorimilar |                     |    |      |      |             |            |             |
|---|---|---------------------|----|------|------|-------------|------------|-------------|
|   | Device                                  | Device Package Type |    | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|   | SN74ACT573DBR                           | SSOP                | DB | 20   | 2000 | 356.0       | 356.0      | 35.0        |
|   | SN74ACT573DWR                           | SOIC                | DW | 20   | 2000 | 367.0       | 367.0      | 45.0        |
|   | SN74ACT573NSR                           | SO                  | NS | 20   | 2000 | 367.0       | 367.0      | 45.0        |
| ı | SN74ACT573PWR                           | TSSOP               | PW | 20   | 2000 | 356.0       | 356.0      | 35.0        |

# **PACKAGE MATERIALS INFORMATION**

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#### **TUBE**

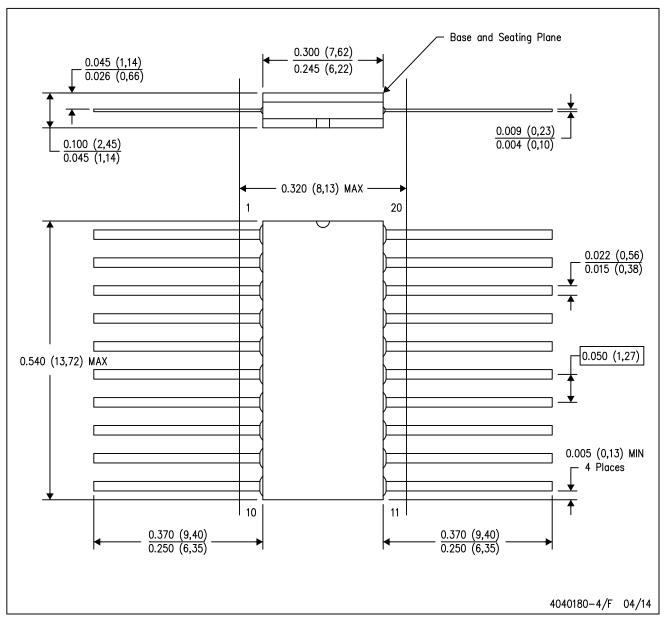


\*All dimensions are nominal

| Device         | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
|----------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| 5962-87664012A | FK           | LCCC         | 20   | 1   | 506.98 | 12.06  | 2030   | NA     |
| 5962-8766401SA | W            | CFP          | 20   | 1   | 506.98 | 26.16  | 6220   | NA     |
| SN74ACT573DW   | DW           | SOIC         | 20   | 25  | 507    | 12.83  | 5080   | 6.6    |
| SN74ACT573N    | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| SN74ACT573PW   | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| SNJ54ACT573FK  | FK           | LCCC         | 20   | 1   | 506.98 | 12.06  | 2030   | NA     |
| SNJ54ACT573W   | W            | CFP          | 20   | 1   | 506.98 | 26.16  | 6220   | NA     |

# W (R-GDFP-F20)

## CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.

  D. Index point is provided on cap for terminal identification only.

  E. Falls within Mil—Std 1835 GDFP2—F20







- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153.



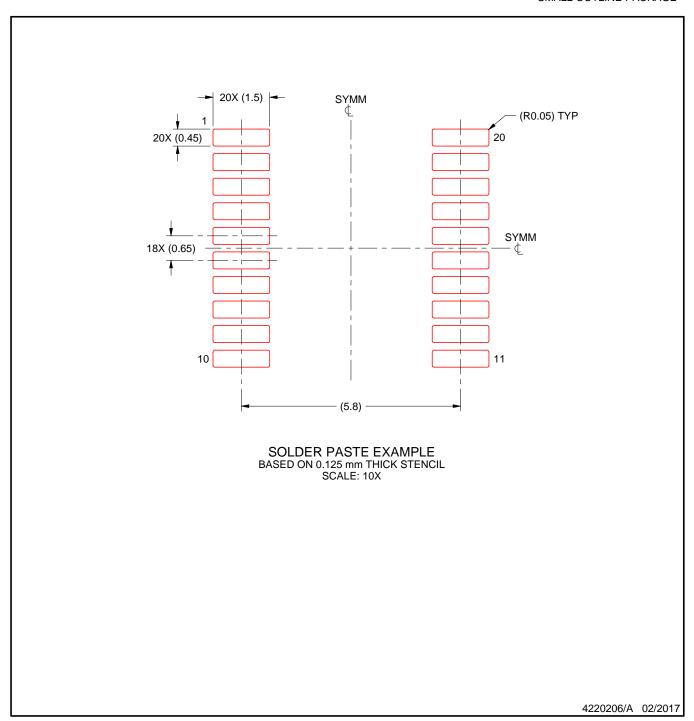


NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.





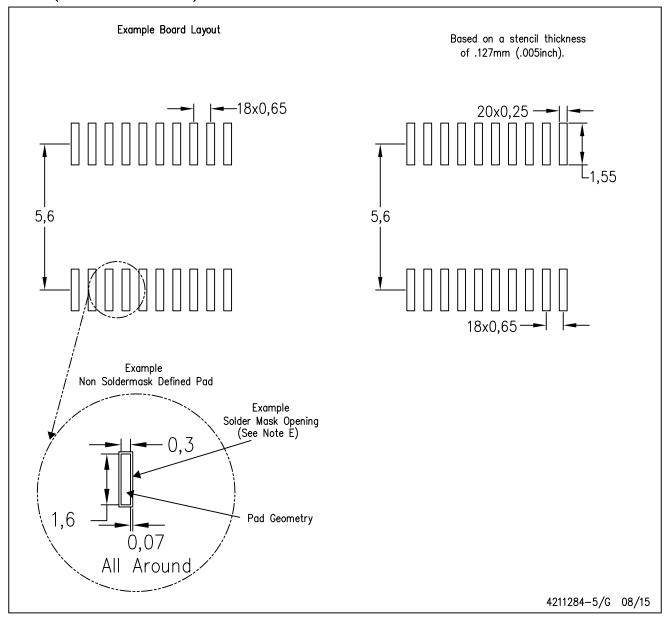
NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



# PW (R-PDSO-G20)

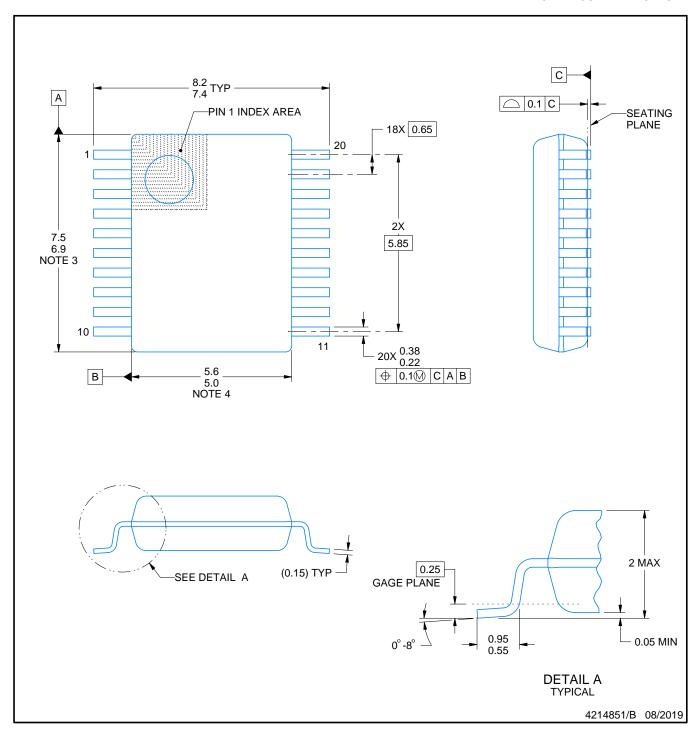
# PLASTIC SMALL OUTLINE



- All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.C. Publication IPC-7351 is recommended for alternate design.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.







- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-150.





NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.





NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.

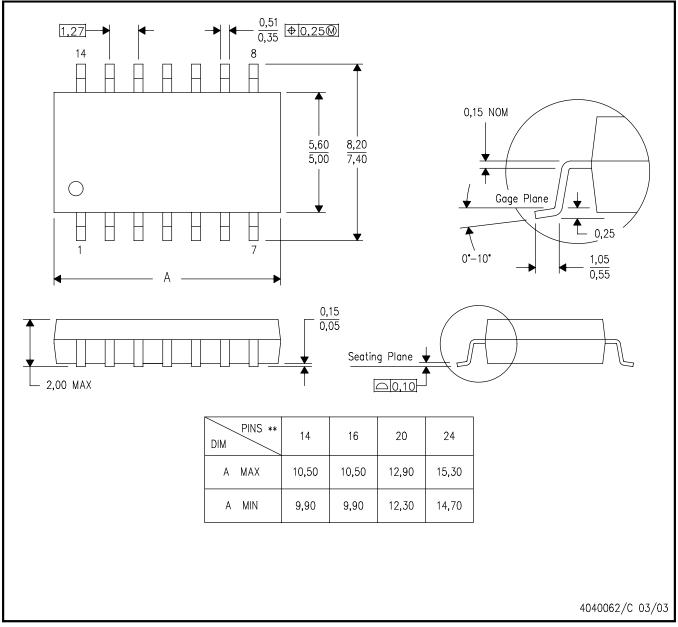


#### **MECHANICAL DATA**

## NS (R-PDSO-G\*\*)

# 14-PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



### 14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

# N (R-PDIP-T\*\*)

## PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN

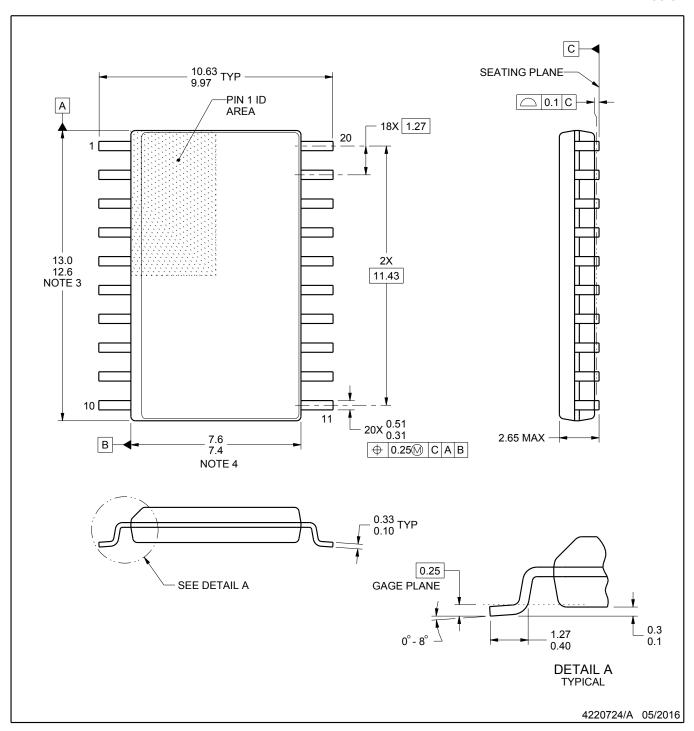


- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.





SOIC



- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
- 5. Reference JEDEC registration MS-013.



SOIC



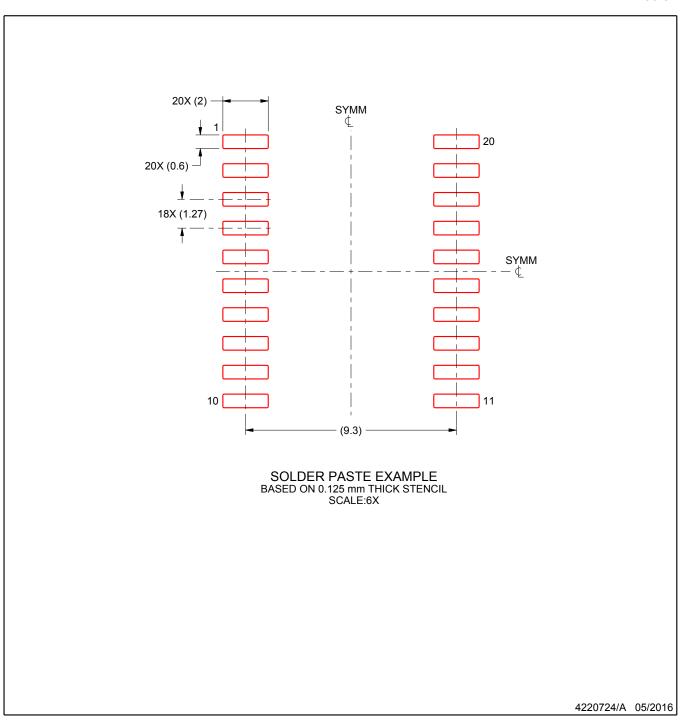
NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOIC



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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